

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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In re Application of:

Zheng, et al.

Serial No.: 10/826,487

Confirmation No.: 1358

Filed:

April 16, 2004

For:

Formation of Protection

Layer by Dripping DI on Wafer With High Rotation to Prevent Stain Formation H₂O₂/H₂SO₄

From

Chemical Splash

MAIL STOP AMENDMENT Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

Group Art Unit: 1765

Examiner:

Patricia Ann George

CERTIFICATE OF MAILING 37 CFR 1.8

I hereby certify that this correspondence is being deposited on 6 /// , 2006 with the United States Postal Service as First Class Mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Signature

RESPONSE TO OFFICE ACTION DATED APRIL 18, 2006

In response to the Office Action dated April 18, 2006, having a shortened statutory period for response set to expire on July 18, 2006, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicants believe that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/APPM/007589/KMT, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

Amendments to the Specification are reflected on page 2 of this paper. Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper. **Remarks** begin on page 7 of this paper.